ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	© Co	terial Compo pyright 2005. IPC, Bannoc nternational and Pan-Ameri	kburn, Illinois	. All rights reserv	tion with low	er level	parts, the	declaratio	n encomp		er level mat	erials for	which th	e item is an assembly ne manufacturer has eclaration.	
1752-2 1.1		Web Site for Informat		-1752 Standa	urd		Form Type * Declaration Class * Distribute Class 6 - RoHS Yes/No, H					Homogeneous Materials and Mfg Informat			
Supplier Information															
Company Name *		Company Unique ID		Unique ID Au	uthority	Resp	onse Date	e *	R	esponse Dod	ument ID				
Mindspeed Techologies	Mindspeed Techologies Inc N/A			N/A			2013-03-22								
Contact Name * Title - Contact			Phone - Cor	ntact *	Emai	Email - Contact *									
Cynthia Ong		Program Manager		949-579-5515			cynthia.ong@mindspeed.com								
Authorized Representat	Authorized Representative * Title - Representative		Э	Phone - Representative *			Email - Representative *			Supplier Comments or URL for Additional Information					
Amy Teng		Quality Engineer		604-6328114	ı	amy.	eng@mir	ndspeed.	.com						
Requester Item Numbe	er	Mfr Item Number		Mfr Item Name		Effecti	ve Date	ate Version Manuf		uring Site	Weight *	UC	DM	Unit Type	
M21151G-33		M21151G-33		35FCBGA 11	56	2011-	05-31	E1	ASE, Ta	wan	19,242.22	2 mg	1	EACH	
Alternate Recommend	ation			NA			Alternate	Item Com	ments NA						
Manufacturing Proce	ss In	formation													
Terminal Plating / Grid Array	Mater	ial	Terminal B	ase Alloy	J-STD-020 MSL	Rating	Peak Prod	ess Body	Temperat	ure Max Time	at Peak Tem	perature	Number	of Reflow Cycles	
SAC 305 N/A			N/A	5			245			do seconds 3					
Comments															
N/A															

Save the fields in this form to a file Export Data Import fields from a file into this form		Locked
RoHS Material Composition Declaration	Declaration Type	* Simplified
RoHS Directive 2002/95/EC RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexaval 2002/95/EC Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Ca		rominated Biphenyls (PBB),
upplier certifies that it gathered the information it provides in this form concerning RoHS restrictive substances using appropriate methods to ensure its accuracy and that such information is at Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws the upplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification ritten agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and or remedies provided as part of that agreement, will be the emedies for issues that arise regarding information the Supplier provides in this form.	nat implement the RoHS Direct applier has not independently von in this paragraph. If the Com	ive. Company acknowledges that erified information provided by others, npany and the Supplier enter into a
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substances per the definition above except for selected exemptions	Supplier Acceptance *	Accepted
exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then sel bove and choose all applicable exemptions.	lect the corresponding re	esponse in the RoHS Declaration
Exemption List Version EL-2006/690/EC		
15. Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages.		
Declaration Signature		

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier	Digital	Signature
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## **Homogeneous Material Composition Declaration for Electronic Products**

**Subltem Instructions:** The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

**Substance Instructions:** [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

Item/SubItem	Homogeneous	Weight	Unit of		Level	Substance Category		Substance	CAS	Exempt	Woight	Unit of	Tolerance		PPM
Name	Material	weight	Measure		Level			Substance	CAS	Exempl	weight	Measure	-	+	FFIVI
M21151G-33	Substrate	8,850.33	mg		С	GROUP-C		Silicon dioxide	7440-50-8		1,199.02	mg			135,47
					С	GROUP-C		Chromium oxide	25068-38-6		53.15	mg			6,005.4
								Barium oxide	108-94-1		13.71	mg			712.49
					С	GROUP-C		Strontium oxide	64742-94-5		2.74	mg			309.59
					С	GROUP-C		Aluminum oxide	7440-31-5		3.22	mg			363.82
					С	GROUP-C		Thallium	Trade Secret		21.66	mg			2,447.3
					С	GROUP-C		Copper oxide	Trade Secret		5	mg			564.95
					С	GROUP-C		Zirconium oxide	Trade Secret		219.44	mg			24,794
					С	GROUP-C		Nickel	65997-17-3		643.95	mg			72,759
					A	Lead/Lead Compound		Boron oxide	7439-92-1		1.89	mg			213.55
					С	GROUP-C		Copper	Trade Secret		3.75	mg			423.71
								Calcium oxide	68-12-2		2.74	mg			142.39
					С	GROUP-C		Palladium	67762-90-7		3.75	mg			423.71
					С	GROUP-C		Gold	Trade Secret		0.68	mg			76.833
					С	GROUP-C		Phosphorous	26265-08-7		482.96	mg			54,569
	lnk	0.5	mg		С	GROUP-C		Phenol	108-92-5		0.015	mg			29,999
					С	GROUP-C		Propylene glycol monon	108-65-6		0.04	mg			79,999
					С	GROUP-C		Triethyl phosphate trieth	78-40-0		0.065	mg			129,99
					С	GROUP-C		Formaldehyde	50-00-0		0.065	mg			129,99
					С	GROUP-C		Isobutyl alcohol	78-83-1		0.015	mg			29,999
					С	GROUP-C		Carbon black	1333-86-4		0.3	mg			599,99
	Heatslug	5,395.96	mg		С	GROUP-C		Chrome	Trade Secret		2.69798	mg			500
					С	GROUP-C		Copper	7440-50-8		5,360.88	emg			993,49

			В	Nickel/Nickel Compou	Nickel	7440-02-0	32.37576	mg	1,682.5
Bump	172.09	mg	A	Lead/Lead Compound	Pb	7439-92-1	165.5254	mg	961,85
			С	GROUP-C	Sn	7440-31-5	6.5646	mg	38,146
Flux	1	mg	С	GROUP-C	Distillates, petroleum, st	64741-44-2	0.175	mg	174,99
			С	GROUP-C	Diethanolamine	111-42-2	0.0505	mg	50,499
			С	GROUP-C	Modified rosin	65997-05-9	0.724	mg	723,99
			С	GROUP-C	Triethanolamine	102-71-6	0.0505	mg	50,499
Thermally condu	75	mg	С	GROUP-C	Inorganic Compounds	Trade Secret	33.75	mg	449,99
			С	GROUP-C	Allylether	Trade Secret	2.25	mg	29,999
			С	GROUP-C	Polymer Resin	Trade Secret	20.625	mg	274,99
			С	GROUP-C	Other	Trade Secret	18.375	mg	244,99
ТІМ	120	mg	С	GROUP-C	Zinc Oxide	1314-13-2	42	mg	349,99
			С	GROUP-C	Resin	Trade Secret	78	mg	649,99
Ball mount flux	2	mg	С	GROUP-C	Nomionic surfactant	68439-49-6	0.56	mg	279,99
			С	GROUP-C	Anime surfactant	61790-85-0	0.78	mg	389,99
			С	GROUP-C	Bara Terpineol	8000-41-7	0.66	mg	329,99
Die	386.83	mg	С	GROUP-C	Silicon	7440-21-3	386.83	mg	999,99
Solder Ball	1,017.78	mg	С	GROUP-C	Sn	7440-31-5	971.9799	mg	954,99
			С	GROUP-C	Cu	7440-50-8	5.0889	mg	5,000
			С	GROUP-C	Ag	7440-22-4	40.7112	mg	40,000
Stiffener ring	3,178.73	mg	С	GROUP-C	Chrome	Trade Secret	1.589365	mg	500
	•		С	GROUP-C	Copper	7440-50-8	3,158.06	8mg	993,49
			В	Nickel/Nickel Compou	Nickel	7440-02-0	19.07238	mg	991.17
Underfill	42	mg	С	GROUP-C	Amine type accelerator	Trade Secret	0.84	mg	19,999
	•		С	GROUP-C	Organic acid anhydride	Trade Secret	8.4	mg	199,99
			С	GROUP-C	Phenolic resin	9003-35-4	0.84	mg	19,999
			С	GROUP-C	1,6-Bis(2,3-epoxypropox	27610-48-6	8.4	mg	199,99
			С	GROUP-C	Additives	Trade Secret	0.84	mg	19,999
			С	GROUP-C	Carbon black	1333-86-4	0.42	mg	9,999.
			С	GROUP-C	Silicon dioxide	60676-86-0	21	mg	499,99
			С	GROUP-C	Bisphenol A type liquid	25068-38-6	1.26	mg	29,999